



From layout to chips

Circuits **M**ulti-**P**rojets®

MPW Services Center for
ICs, Smart Power, Si-Photonics & MEMS
Prototyping & Low Volume Production

<https://mycmp.fr>

Grenoble - France





From layout to chips

2019 CMP Annual Users' Meeting





From layout to chips

Welcome to 36th User meeting

Thank you for joining !

Along with **CMP 2018 activity report** and **2019 technologies' portfolio**, some good news to share with you this year :

- ➔ -CMP partner of **NEXTS-Europractice**
- ➔ -**myCMP** MPW management web app is online
- ➔ -**Add On services** on tracks

Three talks from partners :

- ➔ -**Sara Pellegrini - STMicroelectronics,**
Imaging Technologies at ST
- ➔ -**Christian Terrier - em microelectronic,**
Ultra low power technology through CMP
- ➔ -**Gerhard Koops - ON Semi,**
ON Semi technologies through CMP



Agenda

09:00	Welcome coffee		
09:15-09:25	Introduction	J-Christophe Crébier	CMP
09:25-09:40	2018 activity results	Khouldoun Torki	CMP
09:40-09:55	STMicroelectronics MPW services	Ajith-Sivadasan Moreau	CMP
09:55-10:15	Imaging Technologies at STMicroelectronics	Sara Pellegrini	ST Microelectronics
10:15-10:25	28nm FD-SOI RTL to GDS design flow tutorial, new developments	Christelle Rabache	CMP
10:25-10:40	Flip-chip & Advanced packaging	Lyubomir Kerachev	CMP
10:40-11:10	Break discussion		
11:10-11:25	0.35µm, 0.18µm MPW services	Khouldoun Torki	CMP
11:25-11:45	EM Microelectronic Marin Ultra low power technology services through CMP	Christian Terrier	em microelectronic
11:45-12:05	ON Semi technology services through CMP	Gerhard Koops	ON Semi
12:05-12:20	MEMS & Photonics MPW services, MIRPHAB	François Berthollet	CMP
12:20-12:30	NEXTS (EUROPRACTICE)	Khouldoun Torki	CMP
12:30-12:40	myCMP: MPW specialized web application	Alexandre Chagoya	CMP
12:40-12:50	Add-on services	Jérémy Perret	CMP
12:50-13:00	Closing remarks	J-Christophe Crébier	CMP
13:00-14:30	Lunch discussion		